

## LSL-ST-I-EE (Solder Mask Stripper)

PRODUCT DATA SHEET  
EDITION 01 – 28 June 2013

### PRODUCT DESCRIPTION

LSL-ST-I-EE is a product specially formulated for stripping solder mask even after the final curing.

The solder mask stripper LSL-ST-I-EE offers the following advantages:

- Allows recoating of solder mask after defective product has been fully cured.
- No attack to the basic material occurs, epoxy resin is unaffected.
- No attack on copper, tin, tin/lead, nickel or gold occurs.
- LSL-ST-I-EE can be used diluted and used as a cleaning product.

### APPLICATION

LSL-ST-I-EE is used for stripping fully cured solder mask and UV cured screen printing inks.

### PHYSICAL PROPERTIES

State	Liquid
pH	12.0
Odour	Odourless easily after ammonia
Boiling Point	120°C
Combustibility	Notflammable
Self Combustibility	Not self igniting
Vapour Pressure	None
Density (at 20°C)	1.25g/cm <sup>3</sup>
Solubility in water	Completely miscible

### STRIPPING

The stripping time depends on the type, layer thickness and curing degree of solder mask.

The following tables contain typical stripping time values:

## Manually

LayerThickness	Temperature	Stripping Time
20µm to 30µm	40°C to 45°C	6 hours
	60°C to 70°C	30 minutes
	70°C to 75°C	25 minutes
	80°C to 90°C	9 to 18 minutes
	90°C to 100°C	5 to 7 minutes
More than 30µm	40°C to 45°C	8 hours
	60°C to 70°C	35 minutes
	70°C to 75°C	27 minutes
	80°C to 90°C	12 to 20 minutes
	90°C to 100°C	10 minutes

## Conveyorized equipment

LayerThickness	Temperature	Stripping Time	Pressure
20µm to 30µm	60°C to 70°C	3 to 5 minutes	18 to 22 bar
More than 30µm	65°C to 80°C	4 to 6 minutes	18 to 22 bar

## BRUSHING/RINSING

The attacked solder resist shall be removed by simultaneously brushing and rinsing the panel.  
Polyester brushes (0.3 to 0.4mm diameter) are recommended.

## MAINTENANCE OF THE BATH AND APPLICATION INSTRUCTION

Never exceed the boiling point of the solution: operate below 120°C.

- ✓ Is recommended to filter the solution after processing 20dm<sup>2</sup> of panels per litre.
- ✓ Maintain the solution level by regular additions of water.
- ✓ Cover the bath in order to avoid temperature losses.

## **MICRO-ETCHING**

After manual solder mask stripping of panels, as well for ones temporarily stocked, a micro-etch to remove oxidation will be recommended.

A typical solution should consist of 10ml/l of H<sub>2</sub>SO<sub>4</sub> and 70g/l of Na<sub>2</sub>S<sub>2</sub>O<sub>8</sub>.

Finally the panels must be rinsed and dried properly.

## **CONSUMPTION**

Depending on soldermask thickness: 1 litre of stripping solution can process an average between 3 and 5m<sup>2</sup> PCB.

## **CLEANING RESULTS**

The stripping results are dependant on the type and degree of cure of the soldermask, as well as its thickness.

## **TREATMENT OF THE USED STRIPPED SOLUTION**

1. Neutralize with 96% H<sub>2</sub>SO<sub>4</sub> or with 33% HCl.
2. Binding with [Ca(OH)<sub>2</sub>] and FeCl<sub>3</sub>
3. Addflocculant (amine type)
4. Decantresultant liquor
5. Adjust the pH value with NaOH

## **PACKAGING**

25 litre or 200 litre polyéthylène drums.

## **STORAGE**

Only store LSL-ST-I-EE in original containers, upright, away from direct sunlight and in a dry area at 10-32°C.  
Keep container closed when not in use.

## **HANDLING PRECAUTIONS**

LSL-ST-I-EE is strongly alkaline and can cause burns to skin and eyes.

Protective clothing such as impervious gloves, apron, boots, and chemical safety goggles should be worn when handling this product.

**READ MATERIAL SAFETY DATA SHEET PRIOR TO HANDLING THIS PRODUCT**

**In case of order please indicate this code:**

**LSL-ST-I-EE**

**GC2420**

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